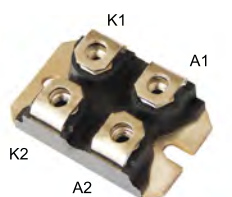
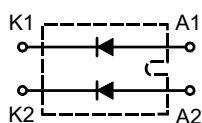
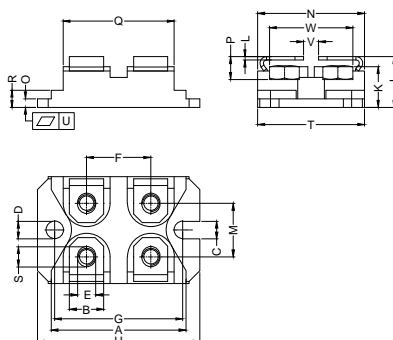


HUR2x100-80

Soft Recovery Behaviour High-Performance Wide Temperature Range Ultra Fast Recovery Epitaxial Diodes



Dimensions SOT -227



Dim.	Millimeter		Dim.	Millimeter	
	Min.	Max.		Min.	Max.
A	31.30	31.65	M	12.00	13.00
B	7.80	8.40	N	25.15	25.65
C	4.00	4.30	O	1.95	2.15
D	∅4.00	∅4.30	P	5.60	6.60
E	4.00	4.30	Q	25.30	26.30
F	14.90	15.20	R	3.90	4.30
G	30.10	30.30	S	4.45	4.85
H	38.00	38.50	T	24.50	25.10
J	12.10	12.90	U	0.05	0.10
K	9.00	9.60	V	3.00	4.80
L	0.75	0.85	W	19.30	20.50



	V_{RSM} V	V_{RRM} V
HUR2x100-80	800	800

Symbol	Test Conditions	Maximum Ratings	Unit
IFRMS	$T_C=60^\circ\text{C}$; rectangular, $d=0.5$	100	A
IFAVM		100	
IFSM	$T_{VJ}=45^\circ\text{C}$; $t_p=10\text{ms}$ (50Hz), sine	980	A
EAS	$T_{VJ}=25^\circ\text{C}$; non-repetitive; $I_{AS}=3\text{A}$; $L=182\mu\text{H}$	2.4	mJ
IAR	$V_A=1.5 \cdot V_R$ typ.; $f=10\text{kHz}$; repetitive	0.35	A
T_{VJ}		-40...+150	$^\circ\text{C}$
T_{VJM}		150	
T_{stg}		-40...+150	
P_{tot}	$T_C=25^\circ\text{C}$	260	W
V_{ISOL}	50/60Hz, RMS, $I_{ISOL} \leq 1\text{mA}$, 1 min 1 sec	2500 3000	V~
M_d	mounting torque (M4) terminal connection torque (M4)	1.1-1.5/9-13 1.1-1.5/9-13	Nm/lb.in.
Weight	typical	30	g

Sirectifier®

HUR2x100-80

Soft Recovery Behaviour High-Performance Wide Temperature Range Ultra Fast Recovery Epitaxial Diodes

Symbol	Test Conditions	Characteristic Values		Unit
		typ.	max.	
I_R	T _{VJ} =25°C; V _R =V _{RRM} T _{VJ} =150°C; V _R =V _{RRM}		1 14	mA
V_F	I _F =100A; T _{VJ} =150°C T _{VJ} =25°C	1.57 1.77	1.75 1.90	V
R_{thJC} R_{thCH}	with heatsink compound	0.12	0.55	K/W
t_{rr}	I _F =1A; -di/dt=400A/us; V _R =30V; T _{VJ} =25°C	45		ns
I_{RM}	V _R =100V; I _F =200A; -diF/dt=100A/us; T _{VJ} =100°C	3.9	6.3	A

FEATURES

- * International standard package SOT-227
- * Isolation voltage 2500 V~
- * 2 independent HiperFRED in 1 package
- * Planar passivated chips
- * Very short recovery time
- * Extremely low switching losses
- * Low I_{RM}-values
- * Soft recovery behaviour
- * UL File NO.E310749
- * RoHS compliant

APPLICATIONS

- * Antiparallel diode for high frequency switching devices
- * Antisaturation diode
- * Snubber diode
- * Free wheeling diode in converters and motor control circuits
- * Rectifiers in switch mode power supplies (SMPS)
- * Inductive heating
- * Uninterruptible power supplies (UPS)
- * Ultrasonic cleaners and welders

ADVANTAGES

- * Avalanche voltage rated for reliable operation
- * Soft reverse recovery for low EMI/RFI
- * Low I_{RM} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch



ORDERING INFORMATION

Part Number	Package	Shipping	Marking Code
HUR2X100-80	SOT-227	10pcs / Tube	HUR2X100-80

HUR2x100-80

Soft Recovery Behaviour High-Performance Wide Temperature Range Ultra Fast Recovery Epitaxial Diodes

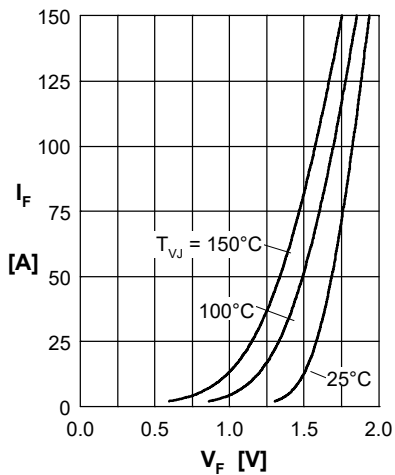


Fig. 1 Forward current I_F versus V_F

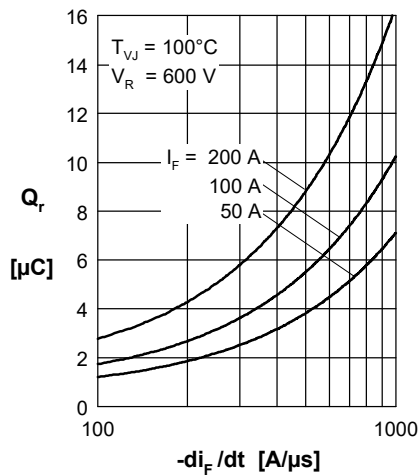


Fig. 2 Typ. reverse recov. charge Q_{rr} versus $-di_F/dt$

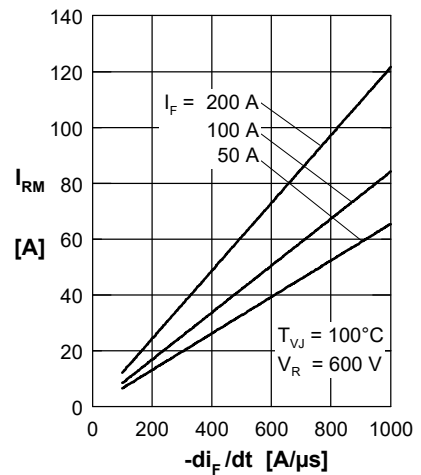


Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$

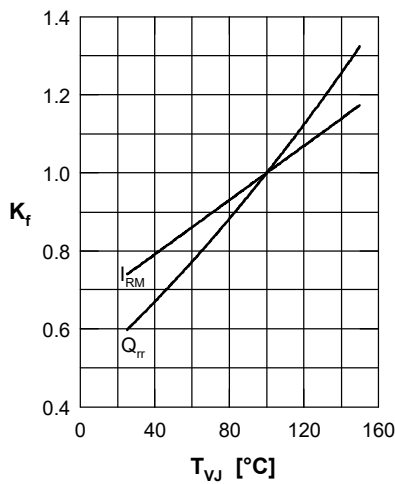


Fig. 4 Dyn. parameters Q_{rr} , I_{RM} versus T_{VJ}

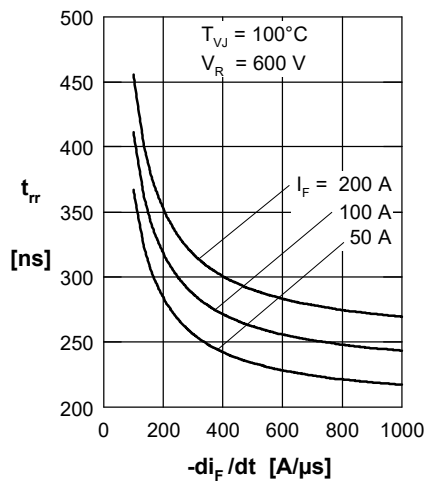


Fig. 5 Typ. recovery time t_{tr} versus $-di_F/dt$

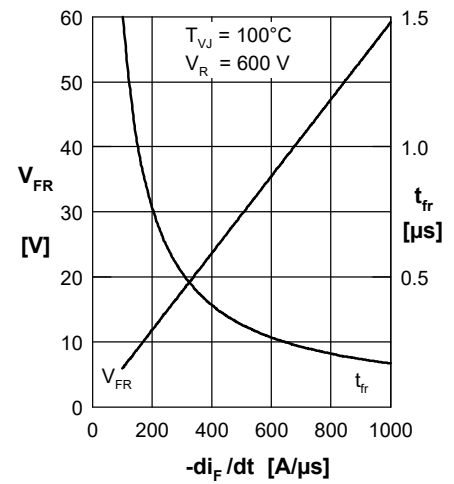


Fig. 6 Typ. peak forward voltage V_{FR} and t_{tr} versus di_F/dt

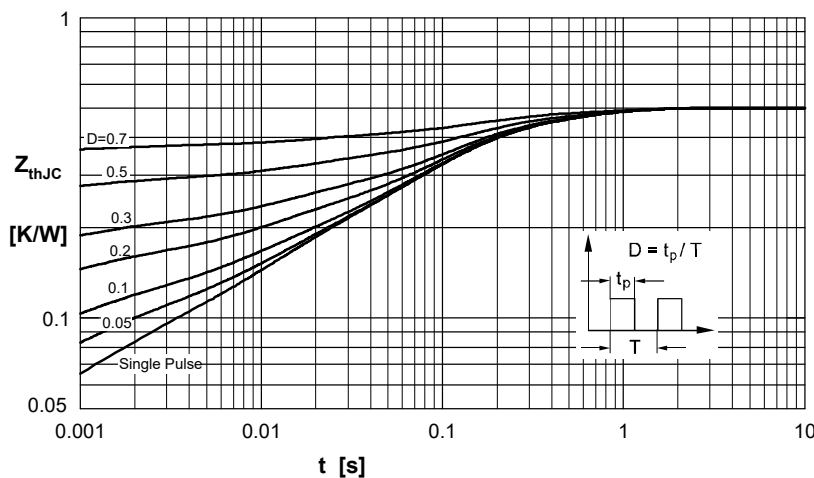


Fig. 7 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.020	0.00002
2	0.050	0.00081
3	0.076	0.01000
4	0.240	0.09400
5	0.114	0.45000